



Low-Power, Single/Dual-Voltage μ P Reset Circuits with Capacitor-Adjustable Reset Timeout Delay

MAX6412-MAX6420

General Description

The MAX6412-MAX6420 low-power microprocessor supervisor circuits monitor system voltages from 1.6V to 5V. These devices are designed to assert a reset signal whenever the V_{CC} supply voltage or RESET IN falls below its reset threshold or the manual reset input is asserted. The reset output remains asserted for the reset timeout period after V_{CC} and RESET IN rise above the reset threshold and the manual reset input is deasserted. The reset timeout is externally set by a capacitor to provide more flexibility.

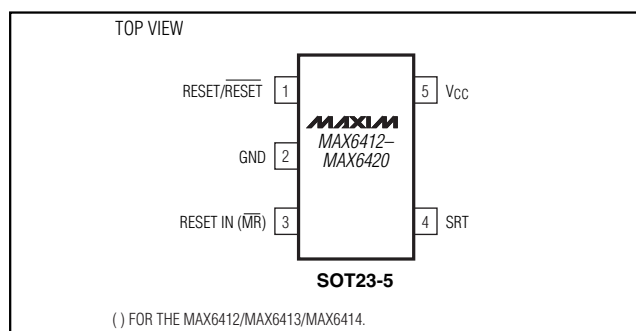
The MAX6412/MAX6413/MAX6414 feature fixed thresholds from 1.575V to 5V in approximately 100mV increments and a manual reset input. The MAX6415/MAX6416/MAX6417 are offered with an adjustable reset input that can monitor voltages down to 1.26V and the MAX6418/MAX6419/MAX6420 are offered with one fixed input and one adjustable input to monitor dual-voltage systems.

The MAX6412/MAX6415/MAX6418 have an active-low, push-pull reset output. The MAX6413/MAX6416/MAX6419 have an active-high, push-pull reset output and the MAX6414/MAX6417/MAX6420 have an active-low, open-drain reset output. All of these devices are offered in a SOT23-5 package and are fully specified from -40°C to +125°C.

Applications

Automotive
Medical Equipment
Intelligent Instruments
Portable Equipment
Battery-Powered Computers/Controllers
Embedded Controllers
Critical μ P Monitoring
Set-Top Boxes
Computers

Pin Configuration



Features

- ◆ Monitor System Voltages from 1.6V to 5V
- ◆ Capacitor-Adjustable Reset Timeout Period
- ◆ Manual Reset Input (MAX6412/MAX6413/MAX6414)
- ◆ Adjustable Reset Input Option (MAX6415-MAX6420)
- ◆ Dual-Voltage Monitoring (MAX6418/MAX6419/MAX6420)
- ◆ Low Quiescent Current (1.7 μ A, typ)
- ◆ 3 RESET Output Options
 - Push-Pull $\overline{\text{RESET}}$
 - Push-Pull RESET
 - Open-Drain $\overline{\text{RESET}}$
- ◆ Guaranteed Reset Valid to $V_{CC} = 1V$
- ◆ Power-Supply Transient Immunity
- ◆ Small SOT23-5 Packages

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX6412UK__-T	-40°C to +125°C	5 SOT23-5
MAX6413UK__-T	-40°C to +125°C	5 SOT23-5
MAX6414UK__-T	-40°C to +125°C	5 SOT23-5
MAX6415UK-T	-40°C to +125°C	5 SOT23-5
MAX6416UK-T	-40°C to +125°C	5 SOT23-5
MAX6417UK-T	-40°C to +125°C	5 SOT23-5
MAX6418UK__-T	-40°C to +125°C	5 SOT23-5
MAX6419UK__-T	-40°C to +125°C	5 SOT23-5
MAX6420UK__-T	-40°C to +125°C	5 SOT23-5

Note: The MAX6412/MAX6413/MAX6414 and MAX6418/MAX6419/MAX6420 are available with factory-set V_{CC} reset thresholds from 1.575V to 5.0V in approximately 0.1V increments. Insert the desired nominal reset threshold suffix (from Table 1) into the blanks following the letters UK. There are 33 standard versions with a required order increment of 2500 pieces. Sample stock is generally held on standard versions only (see Standard Versions Table). Required order increment is 10,000 pieces for nonstandard versions. Contact factory for availability. All devices are available in tape-and-reel only.

Typical Operating Circuit appears at end of data sheet.

Selector Guide appears at end of data sheet.



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ABSOLUTE MAXIMUM RATINGS

All Voltages Referenced to GND

V _{CC}	-0.3V to +6.0V
SRT, $\overline{\text{MR}}$, RESET IN	-0.3V to (V _{CC} + 0.3V)
RESET, $\overline{\text{RESET}}$ (Push-Pull)	-0.3V to (V _{CC} + 0.3V)
RESET (Open-Drain)	-0.3V to +6.0V
Input Current (All Pins)	$\pm 20\text{mA}$
Output Current ($\overline{\text{RESET}}$, RESET)	$\pm 20\text{mA}$

Continuous Power Dissipation (T_A = +70°C)

5-Pin SOT23-5 (derate 7.1mW/°C above +70°C)	571mW
Operating Temperature Range	-40°C to +125°C
Junction Temperature	+150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{CC} = 1V to 5.5V, T_A = T_{MIN} to T_{MAX}, unless otherwise specified. Typical values are at V_{CC} = 5V and T_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage Range	V _{CC}		1.0		5.5	V
Supply Current	I _{CC}	V _{CC} $\leq$ 5.0V		2.7	4.5	μ A
		V _{CC} $\leq$ 3.3V		2	3.5	
		V _{CC} $\leq$ 2.0V		1.7	2.5	
V _{CC} Reset Threshold Accuracy	V _{TH}	T _A = +25°C	V _{TH} - 1.5%		V _{TH} + 1.5%	V
		T _A = 0°C to +125°C	V _{TH} - 2.5%		V _{TH} + 2.5%	
		T _A = -40°C to 0°C	V _{TH} - 3.5%		V _{TH} + 3.5%	
Hysteresis	V _{HYST}			3 $\times$ V _{TH}		mV
V _{CC} to Reset Delay	t _{RD}	V _{CC} falling at 1mV/ μ s		100		μ s
Reset Timeout Period	t _{RP}	C _{SRT} = 1500pF	3.35	4.375	5.40	ms
		C _{SRT} = 0		0.275		
V _{SRT} Ramp Current	I _{RAMP}	V _{SRT} = 0 to 0.65V; V _{CC} = 1.6V to 5V		240		nA
V _{SRT} Ramp Threshold	V _{TH-RAMP}	V _{CC} = 1.6V to 5V (V _{RAMP} rising)		0.65		V
RAMP Threshold Hysteresis		V _{RAMP} falling threshold		33		mV
$\overline{\text{RESET}}$ Output Voltage LOW	V _{OL}	V _{CC} $\geq$ 1.0V, I _{SINK} = 50 μ A			0.3	V
		V _{CC} $\geq$ 2.7V, I _{SINK} = 1.2mA			0.3	
		V _{CC} $\geq$ 4.5V, I _{SINK} = 3.2mA			0.4	
$\overline{\text{RESET}}$ Output Voltage HIGH, (Push-Pull)	V _{OH}	V _{CC} $\geq$ 1.8V, I _{SOURCE} = 200 μ A	0.8 $\times$ V _{CC}			V
		V _{CC} $\geq$ 2.25V, I _{SOURCE} = 500 μ A	0.8 $\times$ V _{CC}			
		V _{CC} $\geq$ 4.5V, I _{SOURCE} = 800 μ A	0.8 $\times$ V _{CC}			
$\overline{\text{RESET}}$ Output Leakage Current, (Open-Drain)	I _{LKG}	V _{CC} > V _{TH} , reset not asserted			1.0	μ A
RESET Output Voltage HIGH	V _{OH}	V _{CC} $\geq$ 1.0V, I _{SOURCE} = 1 μ A	0.8 $\times$ V _{CC}			V
		V _{CC} $\geq$ 1.8V, I _{SOURCE} = 150 μ A	0.8 $\times$ V _{CC}			
		V _{CC} $\geq$ 2.7V, I _{SOURCE} = 500 μ A	0.8 $\times$ V _{CC}			
		V _{CC} $\geq$ 4.5V, I _{SOURCE} = 800 μ A	0.8 $\times$ V _{CC}			

Low-Power, Single/Dual-Voltage μ P Reset Circuits with Capacitor-Adjustable Reset Timeout Delay

ELECTRICAL CHARACTERISTICS (continued)

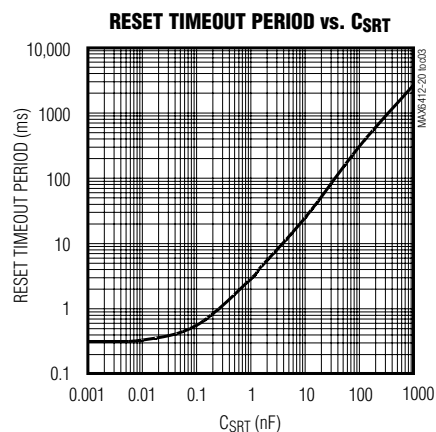
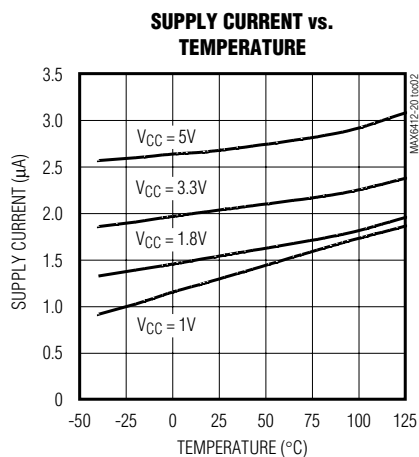
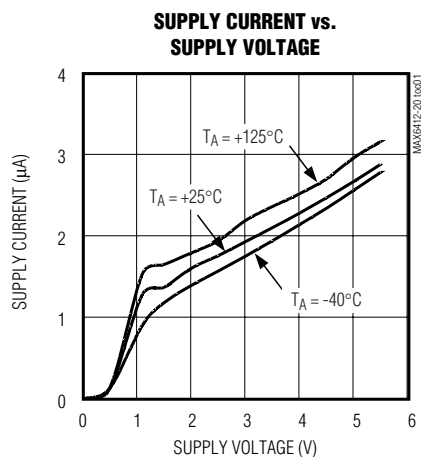
($V_{CC} = 1V$ to $5.5V$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise specified. Typical values are at $V_{CC} = 5V$ and $T_A = +25^\circ C$.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
RESET Output Voltage LOW	V_{OL}	$V_{CC} \geq 1.8V$, $I_{SINK} = 500\mu A$			0.3	V
		$V_{CC} \geq 2.7V$, $I_{SINK} = 1.2mA$			0.3	
		$V_{CC} \geq 4.5V$, $I_{SINK} = 3.2mA$			0.4	
RESET IN Leakage Current					10	nA
RESET IN Threshold	V_{RST}	V_{RST} falling, $V_{CC} = 1.6V$ to $5.0V$	1.212	1.263	1.313	V
RESET IN Hysteresis				25		mV
$\overline{MR}$ Input	V_{IL}	$V_{CC} > 4.0V$			0.8	V
	V_{IH}		2.4			
	V_{IL}	$V_{CC} < 4.0V$			$0.3 \times V_{CC}$	
	V_{IH}		$0.7 \times V_{CC}$			
$\overline{MR}$ Minimum Pulse Width			1			μs
$\overline{MR}$ Glitch Rejection				75		ns
$\overline{MR}$ to RESET Delay				50		μs
$\overline{MR}$ Pullup Resistance		Pull up to V_{CC}	12	20	28	$k\Omega$

Note 1: Devices production tested at $+25^\circ C$. Over temperature limits are guaranteed by design.

Typical Operating Characteristics

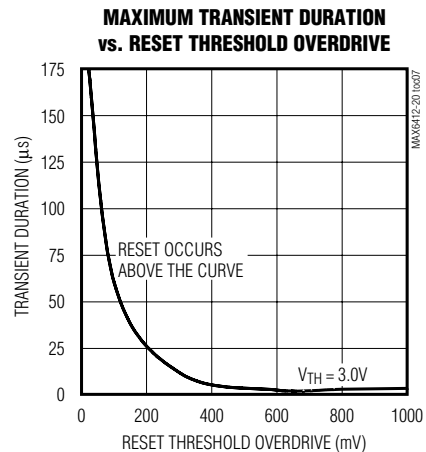
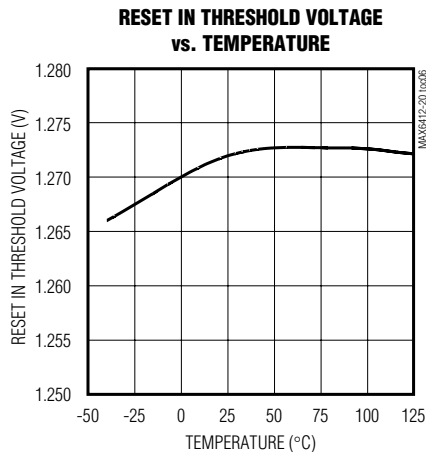
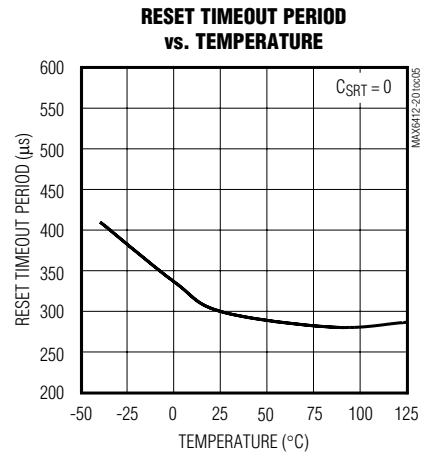
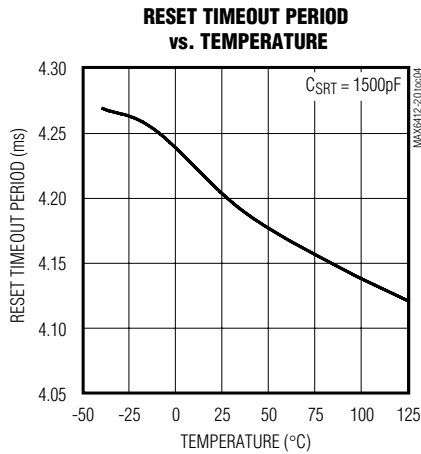
($V_{CC} = 5V$, $C_{SRT} = 1500pF$, $T_A = +25^\circ C$, unless otherwise noted.)



Low-Power, Single/Dual-Voltage μ P Reset Circuits with Capacitor-Adjustable Reset Timeout Delay

Typical Operating Characteristics (continued)

($V_{CC} = 5V$, $C_{SRT} = 1500pF$, $T_A = +25^\circ C$, unless otherwise noted.)



Low-Power, Single/Dual-Voltage μ P Reset Circuits with Capacitor-Adjustable Reset Timeout Delay

Pin Description

MAX6412-MAX6420

PIN			NAME	FUNCTION
MAX6412/ MAX6413/ MAX6414	MAX6415/ MAX6416/ MAX6417	MAX6418/ MAX6419/ MAX6420		
1	1	1	$\overline{\text{RESET}}$	RESET changes from high to low whenever V_{CC} or RESET IN drops below the selected reset threshold voltage (V_{TH} or $V_{RESET\ IN}$, respectively) or manual reset is pulled low. $\overline{\text{RESET}}$ remains low for the reset timeout period after all reset conditions are deasserted and then goes high.
			RESET	RESET changes from low to high whenever the V_{CC} or RESET IN drops below the selected reset threshold voltage (V_{TH} or $V_{RESET\ IN}$) or manual reset is pulled low. RESET remains high for the reset timeout period after all reset conditions are deasserted and then goes low.
2	2	2	GND	Ground
—	3	3	RESET IN	Reset Input. High-impedance input to the adjustable reset comparator. Connect RESET IN to the center point of an external resistor-divider network to set the threshold of the externally monitored voltage. See <i>Reset Threshold</i> section.
3	—	—	$\overline{\text{MR}}$	Manual Reset Input. Pull this pin low to manually reset the device. Reset remains asserted for the reset timeout period after $\overline{\text{MR}}$ is released.
4	4	4	SRT	Set Reset Timeout Input. Connect a capacitor between SRT and ground to set the timeout period. Determine the period as follows: $t_{RP} = (2.73 \times 10^6) \times C_{SRT} + 275\mu s$ with t_{RP} in seconds and C_{SRT} in Farads.
5	5	5	V_{CC}	Supply Voltage and Input for Fixed-Threshold V_{CC} Monitor

Detailed Description

The MAX6412–MAX6420 low-power microprocessor (μ P) supervisory circuits provide maximum adjustability for supply-voltage monitoring and reset functionality. In addition, the MAX6412–MAX6420 reset timeout period is adjustable using an external capacitor.

The MAX6412/MAX6413/MAX6414 have factory-trimmed reset threshold voltages in approximately 100mV increments from 1.575V to 5.0V with a manual reset input. The MAX6415/MAX6416/MAX6417 contain a reset threshold that can be adjusted to any voltage above 1.26V using external resistors. The MAX6418/MAX6419/MAX6420 offer both a factory-trimmed reset threshold and an adjustable reset threshold input for dual-voltage monitoring.

A reset signal is asserted when V_{CC} and/or RESET IN falls below the preset values or when $\overline{\text{MR}}$ is asserted. The reset remains asserted for an externally programmed interval after V_{CC} and/or RESET IN has risen above the reset threshold or $\overline{\text{MR}}$ is deasserted.

Reset Output

The reset output is typically connected to the reset input of a μ P. A μ P's reset input starts or restarts the μ P

in a known state. The MAX6412–MAX6420 μ P supervisory circuits provide the reset logic to prevent code-execution errors during power-up, power-down, and brownout conditions (see *Typical Operating Circuit*).

For the MAX6413, MAX6416, and MAX6419, RESET changes from low to high whenever V_{CC} or RESET IN drops below the reset threshold voltages. Once RESET IN and V_{CC} exceed their respective reset threshold voltage(s), RESET remains high for the reset timeout period, then goes low.

On power-up, once V_{CC} reaches 1V, RESET is guaranteed to be a logic high. For applications requiring valid reset logic when V_{CC} is less than 1V, see the section *Ensuring a Valid RESET/RESET Output Down to $V_{CC} = 0$* .

The active-low $\overline{\text{RESET}}$ output of the remaining supervisors is the inverse of the MAX6413, MAX6416, and MAX6419 active-high RESET output and is guaranteed valid for $V_{CC} \geq 1V$.

Reset Threshold

The MAX6415–MAX6420 monitor the voltage on RESET IN with an external resistor voltage-divider (Figure 1).

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Use the following formula to calculate the externally monitored voltage (V_{MON_TH}):

$$V_{MON_TH} = V_{RST} \times (R1 + R2) / R2$$

where V_{MON_TH} is the desired reset threshold voltage and V_{RST} is the reset input threshold (1.26V). Resistors R1 and R2 can have very high values to minimize current consumption due to low leakage currents. Set R2 to some conveniently high value (1M Ω , for example) and calculate R1 based on the desired monitored voltage, using the following formula:

$$R1 = R2 \times (V_{MON_TH} / V_{RST} - 1) (\Omega)$$

Manual Reset Input (MAX6412/MAX6413/MAX6414)

Many μ P based products require manual reset capability, allowing the operator, a technician, or external logic circuitry to initiate a reset. A logic low on $\overline{MR}$ asserts reset. Reset remains asserted while $\overline{MR}$ is low and for the reset timeout period after $\overline{MR}$ returns high.

The $\overline{MR}$ has an internal 20k Ω pullup resistor so it can be left open if not used. Connect a normally open momentary switch from $\overline{MR}$ to ground to create a manual reset function (external debounce circuitry is not required for long reset timeout periods).

A manual reset option can easily be implemented with the MAX6415–MAX6420 by connecting a normally open momentary switch in parallel with R2 (Figure 2). When the switch is closed, the voltage on RESET IN goes to zero, initiating a reset. Similar to the MAX6412/MAX6413/MAX6414 manual reset, reset remains asserted while the switch is closed and for the reset timeout period after the switch is opened.

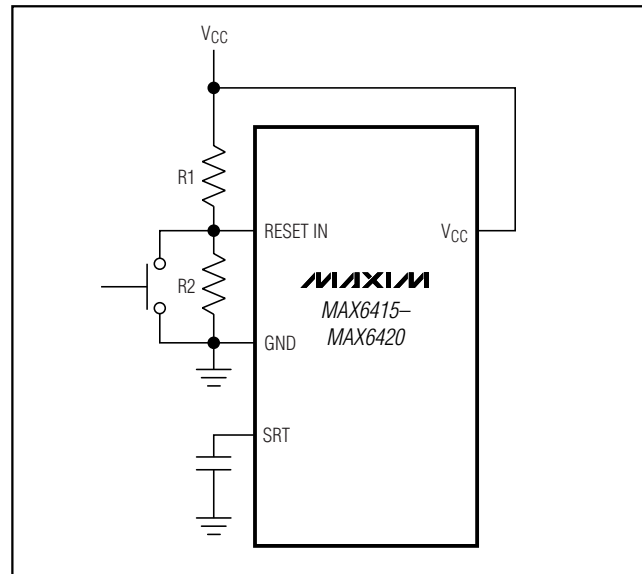


Figure 2. Adding an External Manual Reset Function to the MAX6415–MAX6420

Monitoring Voltages Other than VCC (MAX6415/MAX6416/MAX6417)

The MAX6415/MAX6416/MAX6417 contain an adjustable reset threshold input. These devices can be used to monitor voltages other than VCC. Calculate V_{MON_TH} as shown in the *Reset Threshold* section. (See Figure 3.)

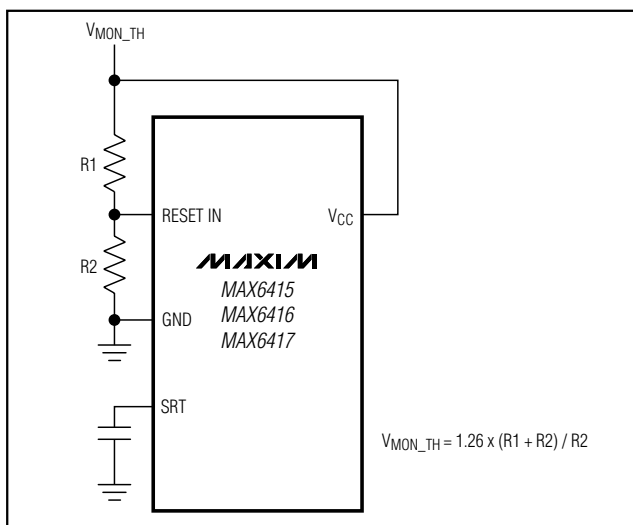


Figure 1. Calculating the Monitored Threshold Voltage (V_{MON_TH})

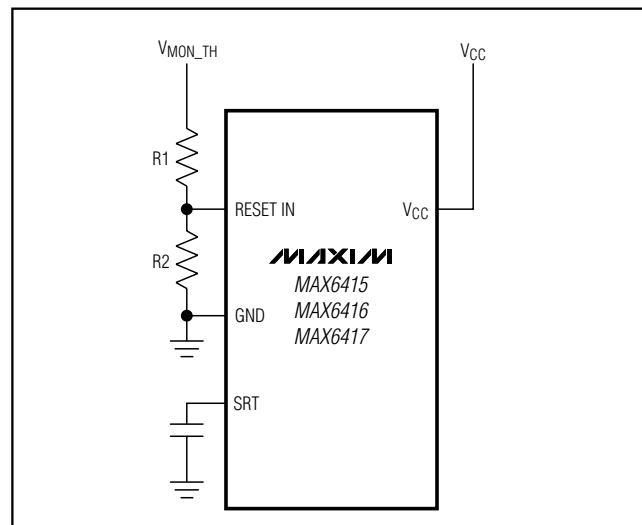


Figure 3. Monitoring External Voltages

Low-Power, Single/Dual-Voltage μ P Reset Circuits with Capacitor-Adjustable Reset Timeout Delay

MAX6412-MAX6420

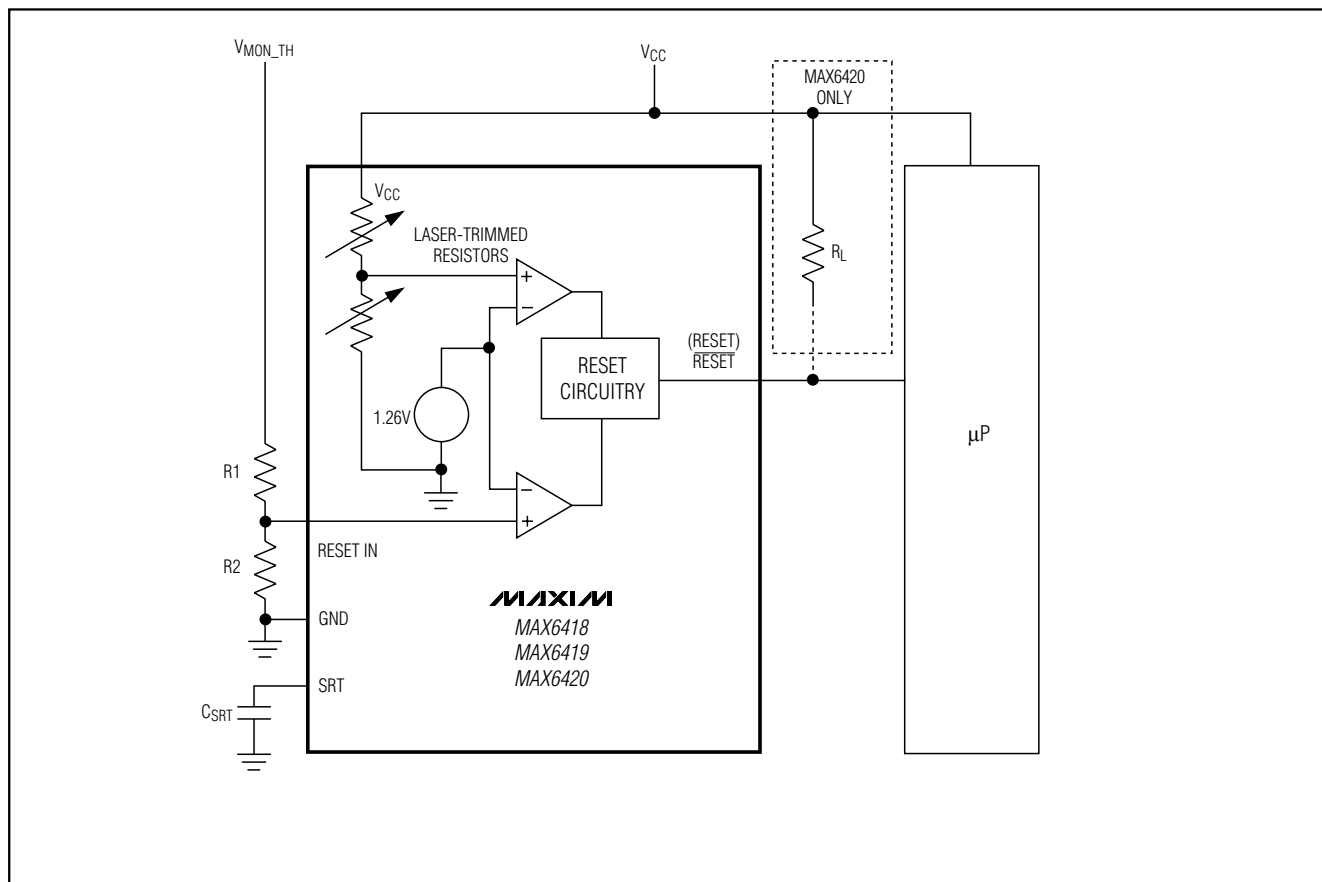


Figure 4. MAX6418/MAX6419/MAX6420 Monitoring Two Voltages

Dual-Voltage Monitoring (MAX6418/MAX6419/MAX6420)

The MAX6418/MAX6419/MAX6420 contain both factory-trimmed threshold voltages and an adjustable reset threshold input, allowing the monitoring of two voltages, V_{CC} and V_{MON_TH} (see Figure 4). Reset is asserted when either of the voltages falls below its respective threshold voltage.

Application Information

Selecting a Reset Capacitor

The reset timeout period is adjustable to accommodate a variety of μ P applications. Adjust the reset timeout period (t_{RP}) by connecting a capacitor (C_{SRT}) between SRT and ground. Calculate the reset timeout capacitor as follows:

$$C_{SRT} = (t_{RP} - 275\mu s) / (2.73 \times 10^6)$$

where t_{RP} is in seconds and C_{SRT} is in Farads

The reset delay time is set by a current/capacitor-controlled ramp compared to an internal 0.65V reference. An internal 240nA ramp current source charges the external capacitor. The charge to the capacitor is cleared when a reset condition is detected. Once the reset condition is removed, the voltage on the capacitor ramps according to the formula: $dV/dt = I/C$. The C_{SRT} capacitor must ramp to 0.65V to deassert the reset. C_{SRT} must be a low-leakage (<10nA) type capacitor, ceramic is recommended.

Operating as a Voltage Detector

The MAX6412-MAX6420 can be operated in a voltage detector mode by floating the SRT pin. The reset delay times for V_{CC} rising above or falling below the threshold are not significantly different. The reset output is deasserted smoothly without false pulses.

Low-Power, Single/Dual-Voltage μ P Reset Circuits with Capacitor-Adjustable Reset Timeout Delay

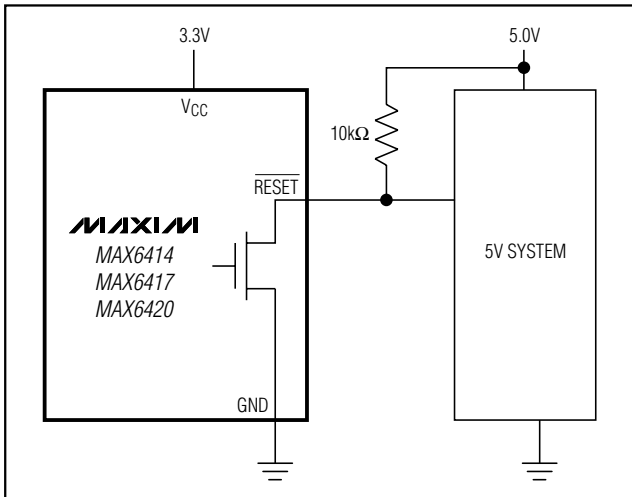


Figure 5. MAX6414/MAX6417/MAX6420 Open-Drain $\overline{\text{RESET}}$ Output Allows use with Multiple Supplies

Interfacing to Other Voltages for Logic Compatibility

The open-drain outputs of the MAX6414/MAX6417/MAX6420 can be used to interface to μ Ps with other logic levels. As shown in Figure 5, the open-drain output can be connected to voltages from 0 to 5.5V. This allows for easy logic compatibility to various microprocessors.

Negative-Going V_{CC} Transients

In addition to issuing a reset to the μ P during power-up, power-down, and brownout conditions, these supervisors are relatively immune to short-duration negative-going transients (glitches). The Maximum Transient Duration vs. Reset Threshold Overdrive graph in the *Typical Operating Characteristics* shows this relationship.

The area below the curve of the graph is the region in which these devices typically do not generate a reset pulse. This graph was generated using a negative-going pulse applied to V_{CC} , starting above the actual reset threshold (V_{TH}) and ending below it by the magnitude indicated (reset-threshold overdrive). As the magnitude of the transient decreases (farther below the reset threshold), the maximum allowable pulse width decreases. Typically, a V_{CC} transient that goes 100mV below the reset threshold and lasts 50 μ s or less will not cause a reset pulse to be issued.

Ensuring a Valid $\overline{\text{RESET}}$ or $\overline{\text{RESET}}$ Down to $V_{CC} = 0$

When V_{CC} falls below 1V, $\overline{\text{RESET}}$ / $\overline{\text{RESET}}$ current sinking (sourcing) capabilities decline drastically. In the case of the MAX6412, MAX6415, and MAX6418, high-

impedance CMOS-logic inputs connected to $\overline{\text{RESET}}$ can drift to undetermined voltages. This presents no problems in most applications, since most μ Ps and other circuitry do not operate with V_{CC} below 1V.

In those applications where $\overline{\text{RESET}}$ must be valid down to 0, adding a pulldown resistor between $\overline{\text{RESET}}$ and ground sinks any stray leakage currents, holding $\overline{\text{RESET}}$ low (Figure 6). The value of the pulldown resistor is not critical; 100k Ω is large enough not to load $\overline{\text{RESET}}$ and small enough to pull $\overline{\text{RESET}}$ to ground. For applications using the MAX6413, MAX6416, and MAX6419, a 100k Ω pullup resistor between $\overline{\text{RESET}}$ and V_{CC} will hold $\overline{\text{RESET}}$ high when V_{CC} falls below 1V (Figure 7). Open-drain $\overline{\text{RESET}}$ versions are not recommended for applications requiring valid logic for V_{CC} down to 0.

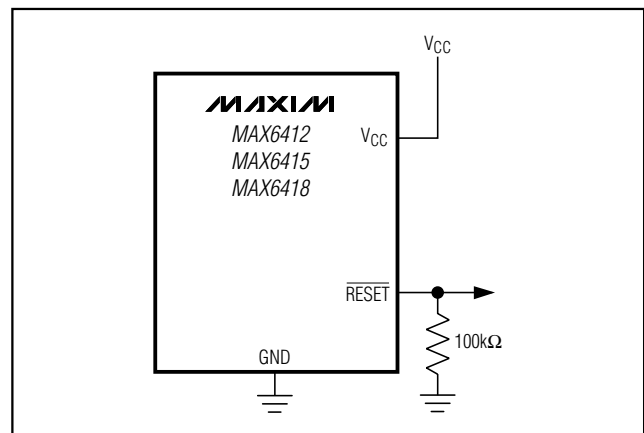


Figure 6. Ensuring $\overline{\text{RESET}}$ Valid to $V_{CC} = 0$

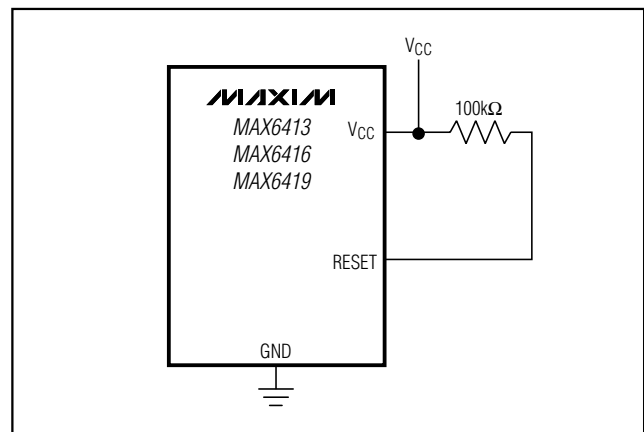


Figure 7. Ensuring $\overline{\text{RESET}}$ Valid to $V_{CC} = 0$

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Layout Consideration

SRT is a precise current source. When developing the layout for the application, be careful to minimize board capacitance and leakage currents around this pin. Traces connected to SRT should be kept as short as possible. Traces carrying high-speed digital signals and traces with large voltage potentials should be routed as far from SRT as possible. Leakage current and stray capacitance (e.g., a scope probe) at this pin could cause errors in the reset timeout period. When evaluating these parts, use clean prototype boards to ensure accurate reset periods.

RESET IN is a high-impedance input, which is typically driven by a high-impedance resistor-divider network (e.g., $1M\Omega$ to $10M\Omega$). Minimize coupling to transient signals by keeping the connections to this input short. Any DC leakage current at RESET IN (e.g., a scope probe) causes errors in the programmed reset threshold.

Chip Information

TRANSISTOR COUNT: 325

PROCESS: BiCMOS

Table 1. Reset Voltages Suffix Table

SUFFIX	MIN	TYP	MAX
16	1.536	1.575	1.614
17	1.623	1.665	1.707
18	1.755	1.800	1.845
19	1.853	1.900	1.948
20	1.950	2.000	2.050
21	2.048	2.100	2.153
22	2.133	2.188	2.243
23	2.313	2.313	2.371
24	2.340	2.400	2.460
25	2.438	2.500	2.563
26	2.559	2.625	2.691
27	2.633	2.700	2.768
28	2.730	2.800	2.870
29	2.852	2.925	2.998
30	2.925	3.000	3.075
31	2.998	3.075	3.152
32	3.120	3.200	3.280
33	3.218	3.300	3.383
34	3.315	3.400	3.485
35	3.413	3.500	3.558
36	3.510	3.600	3.690
37	3.608	3.700	3.793
38	3.705	3.800	3.895
39	3.803	3.900	3.998
40	3.900	4.000	4.100
41	3.998	4.100	4.203
42	4.095	4.200	4.305
43	4.193	4.300	4.408
44	4.266	4.375	4.484
45	4.388	4.500	4.613
46	4.509	4.625	4.741
47	4.583	4.700	4.818
48	4.680	4.800	4.920
49	4.778	4.900	5.023
50	4.875	5.000	5.125

MAX6412-MAX6420

Low-Power, Single/Dual-Voltage μ P Reset Circuits with Capacitor-Adjustable Reset Timeout Delay

Standard Versions Table

PART*	TOP MARK
MAX6412UK16-T	ADVY
MAX6412UK22-T	ADWA
MAX6412UK26-T	ADWC
MAX6412UK29-T	ADWD
MAX6412UK46-T	ADWG
MAX6413UK16-T	ADWI
MAX6413UK22-T	ADWK
MAX6413UK26-T	ADWM
MAX6413UK29-T	ADWN
MAX6413UK46-T	ADWQ
MAX6414UK16-T	ADWS
MAX6414UK22-T	ADWU
MAX6414UK26-T	ADWW
MAX6414UK29-T	ADWX
MAX6414UK46-T	ADXA
MAX6415UK-T	ADZO
MAX6416UK-T	ADZP
MAX6417UK-T	ADZQ
MAX6418UK16-T	ADYG
MAX6418UK22-T	ADYI
MAX6418UK26-T	ADYK
MAX6418UK29-T	ADYL
MAX6418UK46-T	ADYO
MAX6419UK16-T	ADYQ
MAX6419UK22-T	ADYS
MAX6419UK26-T	ADYU
MAX6419UK29-T	ADYV
MAX6419UK46-T	ADYY
MAX6420UK16-T	ADZA
MAX6420UK22-T	ADZC
MAX6420UK26-T	ADZE
MAX6420UK29-T	ADZF
MAX6420UK46-T	ADZI

*Sample Stock is generally held on all standard versions.
Contact factory for availability of nonstandard versions.

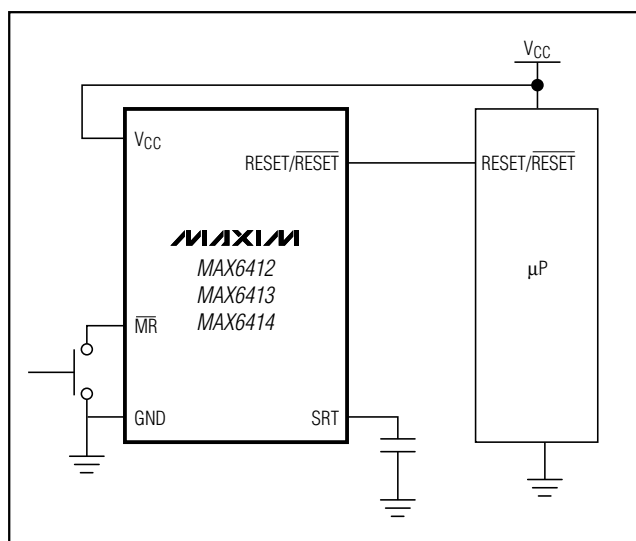
Low-Power, Single/Dual-Voltage μ P Reset Circuits with Capacitor-Adjustable Reset Timeout Delay

Selector Guide

PART	FIXED V_{TH}	MANUAL RESET	RESET IN	PUSH-PULL RESET	PUSH-PULL RESET	OPEN-DRAIN RESET
MAX6412	✓	✓	—	✓	—	—
MAX6413	✓	✓	—	—	✓	—
MAX6414	✓	✓	—	—	—	✓
MAX6415	—	—	✓	✓	—	—
MAX6416	—	—	✓	—	✓	—
MAX6417	—	—	✓	—	—	✓
MAX6418	✓	—	✓	✓	—	—
MAX6419	✓	—	✓	—	✓	—
MAX6420	✓	—	✓	—	—	✓

MAX6412-MAX6420

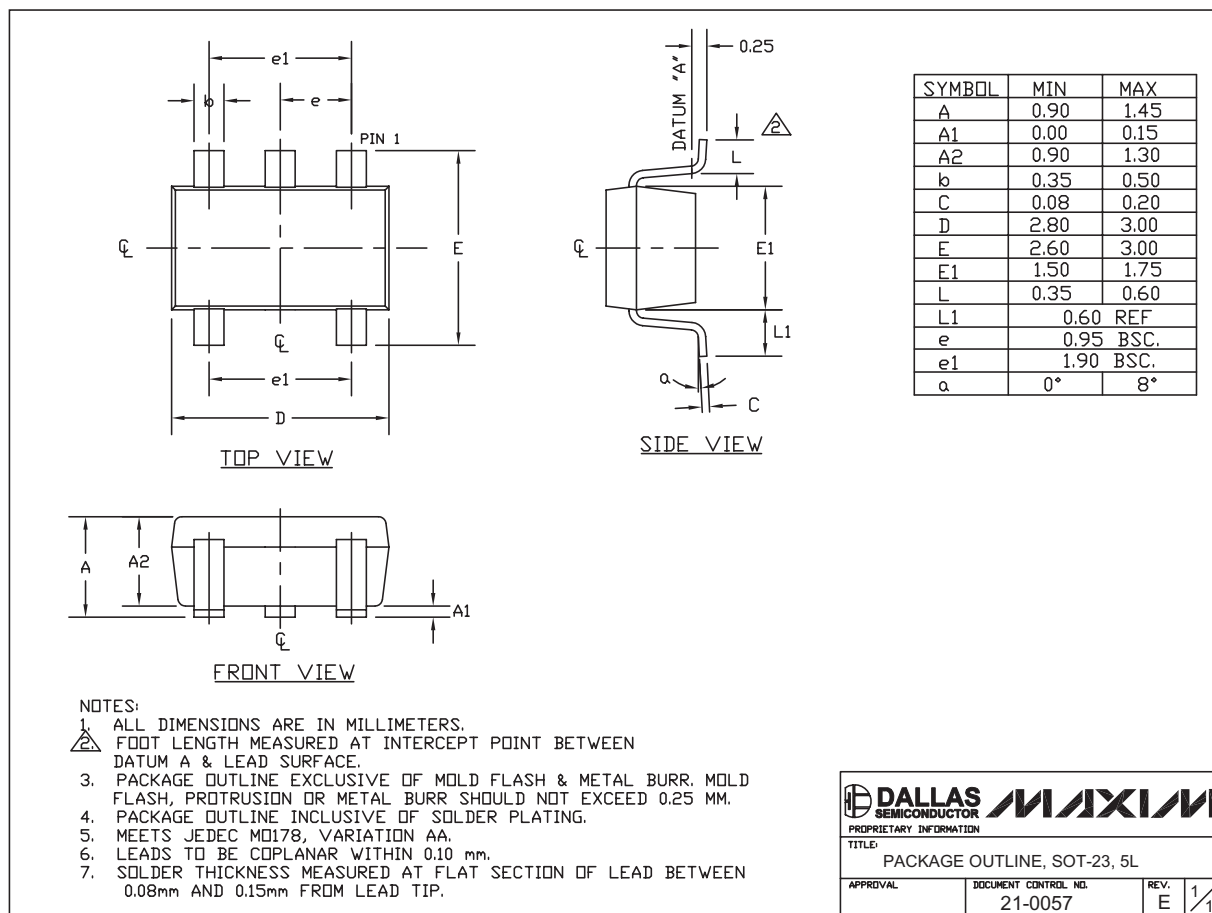
Typical Operating Circuit



Low-Power, Single/Dual-Voltage μ P Reset Circuits with Capacitor-Adjustable Reset Timeout Delay

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to www.maxim-ic.com/packages.)



SOT-23 5L EPS

Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

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